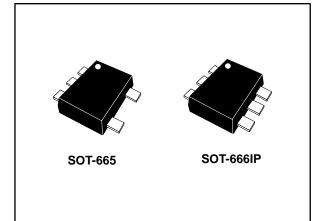


# ESDALC6V1Px

# Low capacitance Transil<sup>™</sup> arrays for ESD protection

Datasheet - production data



### Features

- 2 to 4 unidirectional Transil functions
- Breakdown voltage V<sub>BR</sub> = 6.1 V min
- Low leakage current < 100 nA</li>
- Low diode capacitance (7.5 pF at 3 V)
- Very small PCB area < 2.6 mm<sup>2</sup>

#### **Benefits**

- High ESD protection level
- High integration

#### Complies with the following standards

- IEC 61000-4-2 (exceeds level 4)
  - 20 kV (air discharge)
  - 8 kV (contact discharge)
- MIL STD 883E Method 3015-7: class 3
  - 25 kV HBM (human body model)

### Applications

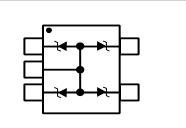
Where transient overvoltage protection in ESD sensitive equipment is required, such as:

- Automotive applications
- Computers
- Printers
- Communication systems
- Cellular phone handsets and accessories
- Wireline and wireless telephone sets
- Set-top boxes

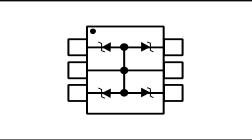
### Description

These devices are monolithic suppressors designed to protect components connected to data and transmission lines against ESD. They clamp the voltage just above the logic level supply for positive transients and to a diode drop below ground for negative transients.

#### Figure 1: ESDALC6V1P5 functional diagram



#### Figure 2: ESDALC6V1P6 functional diagram



TM: Transil is a trademark of STMicroelectronics

March 2017

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This is information on a product in full production.

# 1 Characteristics

Symbol		Value	Unit	
Vpp	Peak pulse voltage	IEC 61000-4-2: Contact discharge Air discharge	8 20	kV
		MIL STD 883G - method 3015-7: Class3	25	
Ррр	Peak pulse power	8/20µs, Tj initial = T <sub>amb</sub>	30	W
T <sub>stg</sub>	Storage temperature rang	-55 to +150		
Tj	Junction temperature	150	°C	
T∟	Maximum lead temperatu	260		
T <sub>op</sub>	Operating temperature ra	ange	-40 to +150	

Table 1: Absolute maximum ratings ( $T_{amb} = 25 \text{ °C}$ )

#### Figure 3: Electrical characteristics (definitions)

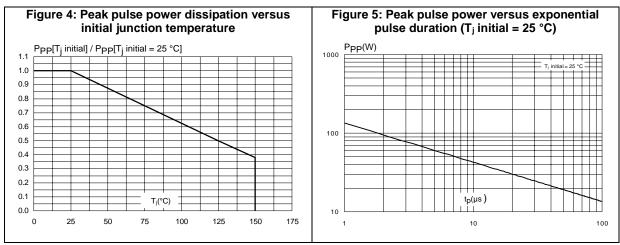
$\begin{array}{llllllllllllllllllllllllllllllllllll$	Parameter Breakdown voltage Clamping voltage Leakage current Forward current Peak pulse current Breakdown current Forward voltage drop Capacitance Dynamic impedance Voltage temperature	VBR Vcl ♥ VRM Slope = 1/Rd	IF VF IRM
--	--	----------------------------------	-----------------

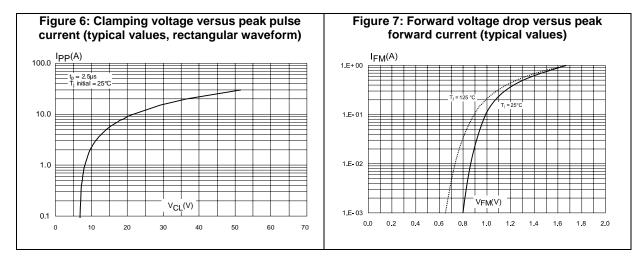
	I able 2: Electrical characteristics (I amb = 25 °C)								
	V <sub>BR</sub> at I <sub>R</sub>			IRM at VRM			Rd	αΤ	С
Order code	Min.	Max.		Тур.	Max.		Тур.	Тур.	Typ. at 3 V
	v	V	mA	nA	μA	v	Ω	10⁻⁴/°C	pF
ESDALC6V1P5 ESDALC6V1P6	6.1	7.2	1	10	0.1	3	1.5	4.5	7.5

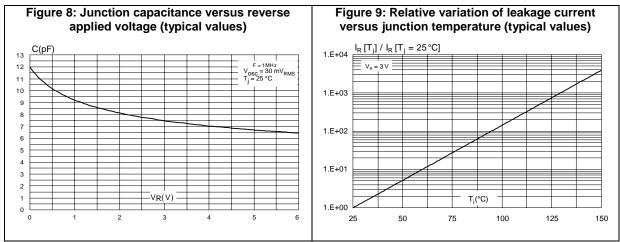
#### Table 2: Electrical characteristics (T<sub>amb</sub> = 25 °C)

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# 1.1 Characteristics (curves)



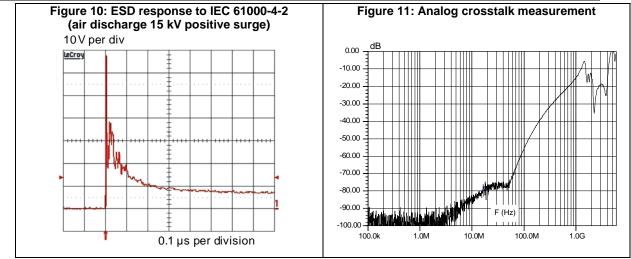


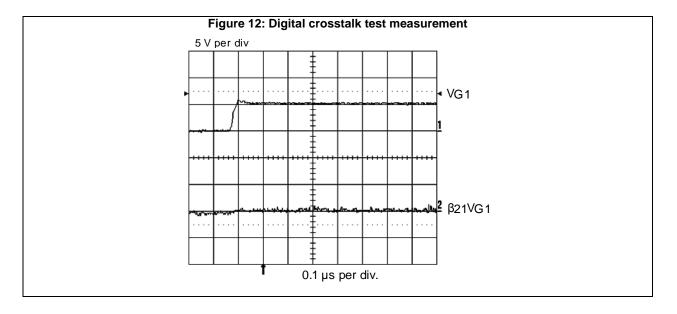


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#### Characteristics

#### ESDALC6V1Px







## 2 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

### 2.1 SOT-665 package information

Figure 13: SOT-665 package outline

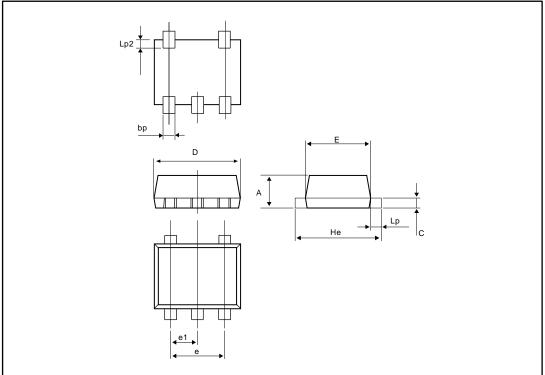


Table 3: SOT-665 package mechanical data

	Dimensions								
Ref.		Millimeters		Inches					
	Min.	Тур.	Max.	Min.	Тур.	Max.			
A	0.5		0.62	0.020		0.024			
bp	0.17		0.27	0.007		0.011			
С	0.08		0.18	0.003		0.007			
D	1.5		1.7	0.060		0.067			
E	1.1		1.3	0.043		0.051			
е		1			0.039				
e1		0.5			0.020				
He	1.5		1.7	0.059		0.067			
Lp	0.1		0.3	0.004		0.012			
Lp2	0.11		0.26	0.004		0.010			



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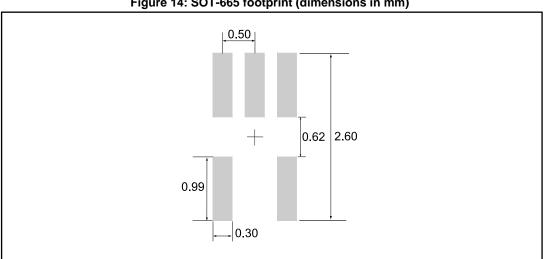
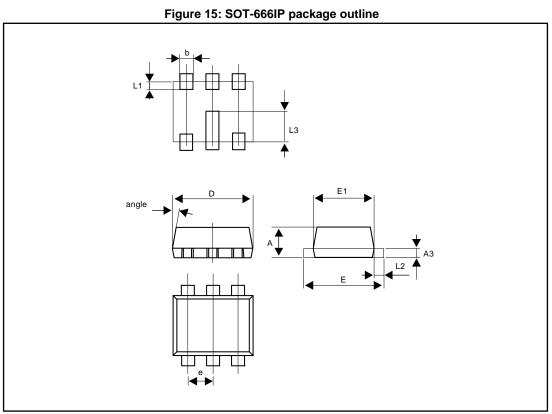


Figure 14: SOT-665 footprint (dimensions in mm)



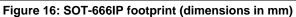
2.2 SOT-666IP package information

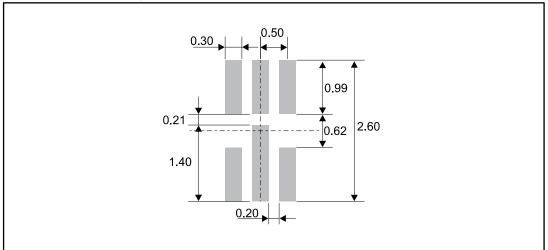


#### Table 4: SOT-666IP package mechanical data

	Dimensions								
Ref.		Millimeters		Inches					
	Min.	Тур.	Max.	Min.	Тур.	Max.			
А	0.45		0.62	0.018		0.024			
A3	0.08		0.18	0.003		0.007			
b	0.17		0.34	0.007		0.0013			
D	1.50		1.70	0.059		0.067			
E	1.50		1.70	0.059		0.067			
E1	1.10		1.30	0.043		0.051			
е		0.5			0.020				
L1		0.19			0.007				
L2	0.1		0.3	0.004		0.012			
L3		0.6			0.024				









# **3** Ordering information

	ESDA LC 6V1 Px
ESD array	
Low capacitance	
Breakdown voltage	
6 = 6.1 Volts min	
Package	

#### Table 5: Ordering information

Order code	Marking <sup>(1)</sup>	Package	Weight	Base qty.	Delivery mode
ESDALC6V1P5	A1	SOT-665	2.0	2000	
ESDALC6V1P6	D	SOT-666IP	2.9 mg	3000	Tape and reel

#### Notes:

 $^{(1)}\mbox{The}$  marking can be rotated by multiples of  $90^\circ$  to differentiate assembly location



## 5

# Revision history

Date	Revision	Changes
16-Aug-2006	1	ESDALC6V1P3, ESDALC6V1P5, and ESDALC6V1P6 merged and reformatted to current standards.
23-Aug-2006	2	Table 1 on page 2: Temperature range upgraded to $T_j max = 150 \ ^{\circ}C$
11-Oct-2006	3	Added values for VPP in Table 1.
23-Apr-2008	4	Reformatted to current standards. Added $I_{RM}$ typical value in <i>Table 2.</i> Update minimum dimension for L2 of SOT-663 in <i>Table 3.</i>
15-Jan-2010	5	Updated Figure 17: SOT-665 footprint (dimensions in mm).
03-Dec-2014	6	Updated SOT-666IP dimension definitions and reformatted to current standard.
17-Mar-2017	7	Removed SOT-663 package. Updated Table 1: "Absolute maximum ratings (Tamb = 25 °C)". Updated Table 3: "SOT-665 package mechanical data" and Table 3: "SOT-665 package mechanical data".

Table 6: Document revision history



#### ESDALC6V1Px

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